

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEI DUAN	04/12/2018
QIANG MA	04/12/2018
JIA RUI TANG	04/12/2018
RECEIVING PARTY DATA	
Name:	EMC IP HOLDING COMPANY LLC
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15953766
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	MUIRHEAD AND SATURNELLI, LLC
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ATTORNEY DOCKET NUMBER:	EMS-687US
NAME OF SUBMITTER:	ANNE E. SATURNELLI
SIGNATURE:	/Anne E. Saturnelli/
DATE SIGNED:	04/16/2018
Total Attachments: 4	
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ASSIGNMENT

WHEREAS, we, Wei DUAN, Qiang MA and Jia Rui TANG, have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled TECHNIQUES FOR GENERATING CUSTOMIZED SOFTWARE, the specification of which:

- is being executed on even date herewith and is about to be filed in the United States Patent Office;
- was filed on _____ as U.S. Application No. _____;
- was patented under U.S. Patent No. _____ on _____.

WHEREAS, EMC IP HOLDING COMPANY LLC (hereinafter "ASSIGNEE"), which is a corporation organized and existing under the laws of Delaware and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

AND, we hereby authorize attorneys of Muirhead and Saturnelli, LLC to insert here in parenthesis (_____) the application number and filing date of said Application (or foreign counterpart application) to facilitate the recording or other official processing of this Assignment.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date: 2018. 4. 12

Wei Duan
Inventor's Signature

Print full name of first inventor: **Wei DUAN**
Residence: COFCO Xiangyun, Taiping Yuan Middle 5th Rd
Wuhou, Chengdu, Sichuan, China, 610043
Citizenship: CHINA
Mailing Address: Same as above

I Chen Baifu (name) whose residential address is
Room 1605, Building 1, Huixia Shaocheng, Daxue Qingyang Chengdu
was personally present and did see Wei Duan (name of person signing the assignment) who is personally known to me, execute the above assignment.

Chen Baifu (signature of first witness)

Signed at Dell EMC Chengdu COE (location of witness signature)

on this day 12.12 of 20 18 (date of signature)

I Mao Zhu (name) whose residential address is
15/F, Building 11, Tianyuefu, No. 18 Sheng'an Street, Chengdu
was personally present and did see Wei Duan (name of person signing the assignment) who is personally known to me, execute the above assignment.

Mao Zhu (signature of second witness)

Signed at Dell EMC Chengdu COE (location of witness signature)

on this day 4. 12 of 20 18 (date of signature)

Date: 2018.4.12

Qiang Ma
Inventor's Signature

Print full name of second inventor: Qiang MA
Residence: 8-2-2201, Number 169, 2nd BinHe Road
Huayang Town, Chengdu, China
Citizenship: CHINA
Mailing Address: Same as above

I Mao, Zhu (name) whose residential address is
15/F, Building 11, Tianyuefu, No.18 Shengan Street, Chengdu

was personally present and did see Qiang Ma (name of person signing the assignment) who is personally known to me, execute the above assignment.

Mao, Zhu (signature of first witness)

Signed at Dell EMC Chengdu COE (location of witness signature)

on this day 4.12 of 2018. (date of signature)

I Qian Zhang (name) whose residential address is

20F, Building 12, Jinglong, No.99 street, Chengdu.

was personally present and did see Qiang Ma (name of person signing the assignment) who is personally known to me, execute the above assignment.

Qian Zhang (signature of second witness)

Signed at DELL EMC Chengdu COE (location of witness signature)

on this day 4.12 of 2018. (date of signature)

Date: 2018.4.12

Jia Rui Tang
Inventor's Signature

Print full name of third inventor:

Jia Rui TANG

Residence:

Room 2705 , Block 3, Tianhua 199th Rd
Gaoxin District, Chengdu, Sichuan, China, 610043

Citizenship:

CHINA

Mailing Address:

Same as above

I Chen Baifu (name) whose residential address is

Room 1605, Building 1, Huixia Shaocheng, District Qingyang, Chengdu

was personally present and did see Jia Rui Tang (name of person signing the assignment) who is personally known to me, execute the above assignment.

Chen Baifu (signature of first witness)

Signed at Dell EMC Chengdu CO (location of witness signature)

on this day 4.12 of 20 18. (date of signature)

I Chen Peng (name) whose residential address is

Room 1501, Building 10, Jingchen Road NO.100, Cheng Du

was personally present and did see Jia Rui Tang (name of person signing the assignment) who is personally known to me, execute the above assignment.

Chen Peng (signature of second witness)

Signed at Dell EMC Chengdu CO (location of witness signature)

on this day 4.12 of 20 18. (date of signature)